

**A METHOD FOR COATING A SEMICONDUCTOR SUBSTRATE WITH A
MIXTURE CONTAINING AN ADHESION PROMOTER**

ABSTRACT OF THE DISCLOSURE

A method of coating a semiconductor substrate material with a coating material consisting of the steps of mixing an adhesion promoter with a coating material and applying the mixture to a semiconductor substrate material. The invention also includes means for coating a semiconductor substrate material with a coating material comprising means for mixing adhesion promoters with coating materials and means for applying the mixture of adhesion promoters and coating materials to a semiconductor substrate.